

Issue Date: 30 August 2016

Title of Change:	Qualification of Maxchip Electronic Corp. (MXP) in Taiwan as an additional wafer fab site for the listed products.				
Proposed first ship date:	7 December 2016				
Contact information:	Contact your local ON Semiconductor Sales Office or < Osamu.Akaki@onsemi.com>				
Samples:	Contact your local ON Semiconductor Sales Office				
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or < Yasuhiro.lgarashi@onsemi.com>.				
Type of notification:	This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days prior to implementation of the change. ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <pcn.support@onsemi.com>.</pcn.support@onsemi.com>				
Change Part Identification:	Affected products will be identified with date code.				
Change category:	Wafer Fab Change Assembly Change Test Change Other				
Change Sub-Category(s): Datasheet/Product Doc change Manufacturing Site Change/Addition Material Change Shipping/Packaging/Markin Other: 					
Sites Affected:	oplicable ON Semiconductor site(s) : External Foundry/Subcon site(s)				
Description and Purpose:					
This Final Product/Process Change Notification (FPCN) announces the addition of Maxchip Electronics Corp (MXP) as a wafer fabrication site for the list of ON Semiconductor products below. Maxchip Electronics Corp. (MXP) is located in Hsinchu, Taiwan, and is ISO9001 certified. The product design and electrical specifications will not change. A full electrical characterization over the temperature range is performed for each product to check the device functionality and electrical specifications.					
Qualification tests are designed to show that the reliability of the affected products will continue to meet or exceed ON Semiconductor standards.					



eliability Data Summary:							
Test	Specification	Condition		Interval	Results		
HTRB	JESD22-A108	Ta=150°C, 80% max rated VSSS		1008 hrs	0/231		
HTGB	JESD22-A108	Ta=150°C, 100% max rated Vgss		1008 hrs	0/231		
HTSL	JESD22-A103	Ta=150°C		1008 hrs	0/75		
IOL	MIL-STD-750	Ta=+25°	°C, delta Tj=100°C				
	(M1037)	On/off = 2 min 15000 cy		15000 cyc	0/75		
	AEC-Q101						
TC	JESD22-A104	Ta= -40°C to +125°C		850 сус	0/231		
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias		96 hrs	0/75		
uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased		96 hrs	0/75		
ectrical Character	istic Summary: ics are not impacted.						
st of Affected Standard Parts:							
Part Number			Qualification Vehicle				
EFC6604R-TR			EFC6612R-TF				